

WG40N120MFW1

Rev.01 - 24 October 2023

IGBT

Preliminary data sheet

1. General description

WG40N120MFW1 uses advanced Fine Trench Field-stop IGBT technology with anti-parallel diode in TO-247 package. This device is part of the M series of IGBTs, which represents an optimum compromise between conduction and switching losses to maximize the efficiency of high switching frequency converter.



2. Features and benefits

- Maximum junction temperature 175 °C
- M speed switching series
- · Positive Temperature efficient for Easy Parallel Operating
- Very soft, fast recovery anti-parallel diode
- EMI Improved Design

3. Applications

- Solar inverter
- UPS
- Welding converters
- PFC
- Mid to high switching frequency applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter		Notes	Value			Unit
V_{CE}	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$			1200			V
I _C	DC collector current, limited by $T_{j(max)}$ T _c = 100 °C				40		A
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static characteristics							
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V _{GE} = 15 V; I _C = 40 A; T _j = 25 °C		-	1.68	2.1	V

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		۹C
2	С	collector		
3	E	emitter		
mb	C	mounting base; connected to collector		G E sym200

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	Name		method	quantity	version	issue date		
WG40N120MFW1	TO247		Tube	30	SOT429	25-Mar-2013		

7. Marking

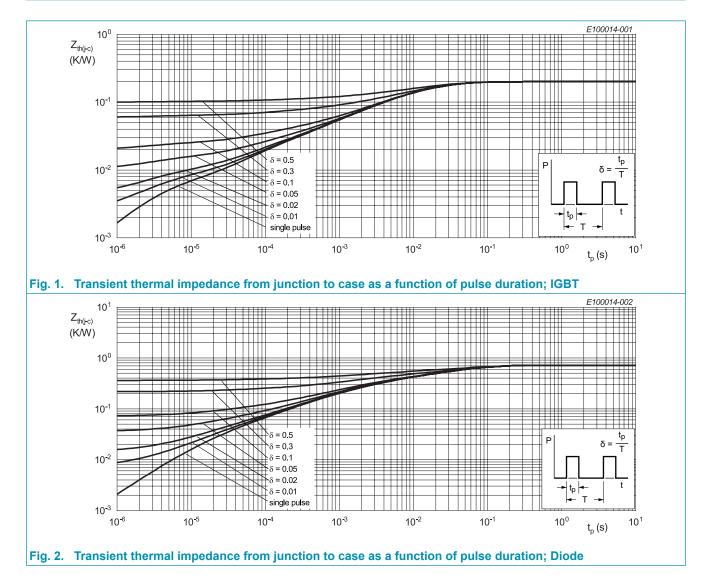
Table 4. Marking codes	
Type number	Marking codes
WG40N120MFW1	G40N120 MFW1

8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V _{CE}	Collector-emitter voltage, $T_j \ge 25 \degree C$		1200	V
I _C	DC collector current, limited by $T_{j(max)}$ T _c = 25 °C T _c = 100 °C		80 40	А
I _{C(puls)}	Pulsed collector current, $t_{\rm p}$ limited by $T_{j(max)}$		120	А
-	Turn off safe operating area V _{CE} \leq 1200 V, T _j \leq 125 °C, t _p = 1 µs		120	A
I _F	Diode forward current, limited by $T_{j(max)}$ $T_{c} = 25 \text{ °C}$ $T_{c} = 100 \text{ °C}$		80 40	A
I _{Fpuls}	Diode pulsed current, t_p limited by $T_{j(max)}$		120	А
V_{GE}	Gate-emitter voltage		±20	V
P _{tot}	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		750 375	W
t _{sc}	Short circuit withstand time $V_{GE} = 15.0 \text{ V}, V_{CC} \le 600 \text{ V}$ Allowed number of short circuits < 1000 Time between short circuits: $\ge 1.0 \text{ s}$ $T_j = 125^{\circ}\text{C}$		10	us
T _{stg}	Storage temperature		-55 to +150	°C
Tj	Operating junction temperature		175	°C
-	Peak soldering temperture		260	°C
M	Mounting Torque with washer		0.55	Nm

9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-c)}	IGBT thermal resistance from junction to case			-	0.20	-	K/W
$R_{th(j-c)}$	Diode thermal resistance from junction to case			-	0.72	-	K/W
R _{th(j-a)}	thermal resistance from junction to ambient			-	40	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics	·					
BV_{CES}	Collector-emitter breakdown voltage	V _{GE} = 0 V; I _C = 1 mA		1200	-	-	V
$V_{\text{CE(sat)}}$	Collector-emitter saturation	V _{GE} = 15 V; I _C = 40 A; T _j = 25 °C		-	1.68	2.1	V
	voltage	V _{GE} = 15 V; I _C = 40 A; T _j = 175 °C		-	2.2	-	V
V _F Diode forw	Diode forward voltage	V _{GE} = 0 V; I _F = 40 A; T _j = 25 °C		-	2.3	-	V
		V _{GE} = 0 V; I _F = 40 A; T _j = 175 °C		-	2.1	-	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	I_{c} = 0.5 mA; V_{ce} = V_{ge}		4.2	5.3	6.4	V
I _{CES}	Zero gate voltage collector current	V_{CE} = 1200 V; V_{GE} = 0 V; T_{j} = 25 °C		-	-	250	μA
		V _{CE} =1200 V;V _{GE} = 0 V; T _j = 175 °C		-	-	10	mA
g _{fs}	Transconductance	V _{CE} = 20 V; I _C = 40 A		-	22	-	S
Dynamic	characteristics						
C _{ies}	Input capacitance	V _{CE} = 30 V; V _{GE} = 0 V; f = 1 MHz;		-	6662	-	pF
C _{oes}	Output capacitance	T _j = 25 °C		-	137	-	pF
C _{res}	Reverse transfer capacitance			-	25	-	pF
Q _G	Gate charge	V _{CC} = 960 V; I _C = 40 A; V _{GE} = 15 V; T _i = 25 °C		-	200	-	nC

Max

-

Unit

nS

Тур

60

11. Switching Characteristics

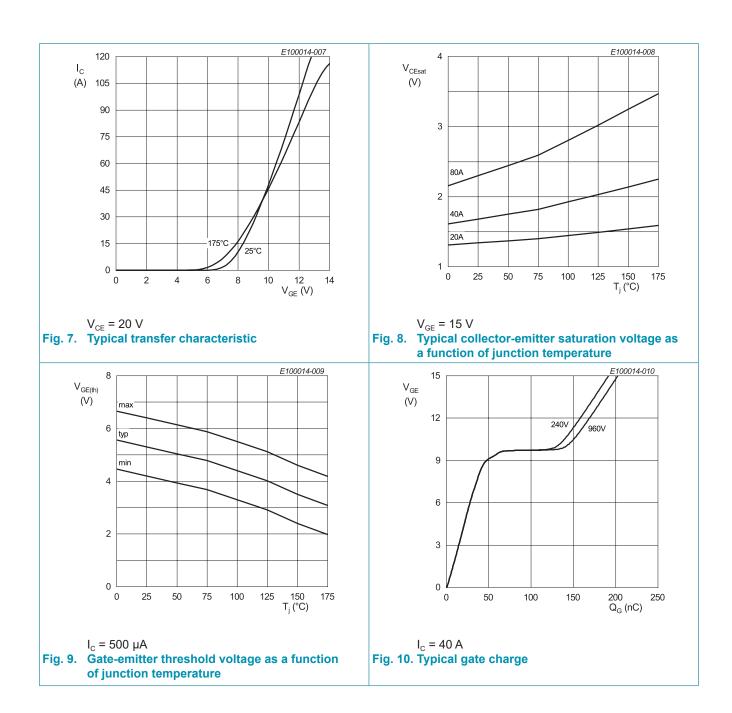
۲able 8. Sv	witching Characteristics	, Inductive Load		
Symbol	Parameter	Conditions	Notes	Min
IGBT cha	racteristics			
t _{d(on)}	Turn-on delay time	$T_j = 25 °C;$		-
t,	Rise time	$V_{cc} = 600 \text{ V}; \text{ I}_c = 40 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_c = 10 \text{ O}$		-

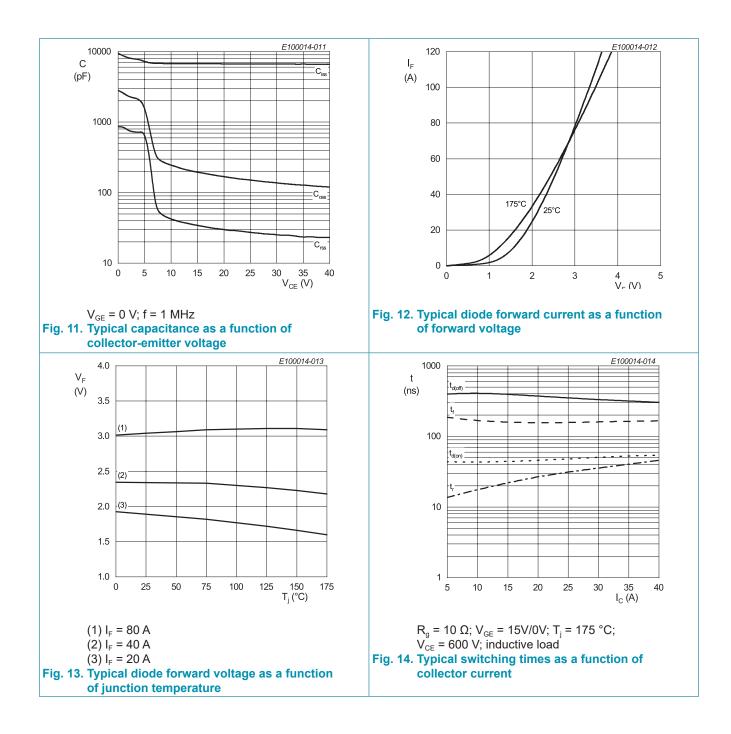
•d(on)	rain on doldy line			00		
t _r	Rise time	$V_{cc} = 600 \text{ V}; \text{ I}_{c} = 40 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V}; \text{ R}_{G} = 10 \Omega$	-	46	-	nS
$t_{\rm d(off)}$	Turn-off delay time		-	254	-	nS
t _f	Fall time		-	101	-	nS
Eon	Turn-on energy		-	2.5	-	mJ
E_{off}	Turn-off energy		-	1.7	-	mJ
E _{ts}	Total switching energy		-	4.2	-	mJ
$t_{\rm d(on)}$	Turn-on delay time	T _j = 175 °C;	-	54	-	nS
t _r	Rise time	$V_{cc} = 600 \text{ V}; \text{ I}_{c} = 40 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_{c} = 10 \Omega$	-	46	-	nS
$t_{\rm d(off)}$	Turn-off delay time		-	303	-	nS
t _f	Fall time		-	167	-	nS
E _{on}	Turn-on energy		-	4	-	mJ
E_{off}	Turn-off energy		-	2.5	-	mJ
E _{ts}	Total switching energy		-	6.5	-	mJ
Diode ch	naracteristics	· · · · · ·				
t _{rr}	Reverse recovery time	$T_j = 25 \text{°C};$	-	200	-	nS
Q _r	Reverse recovery charge	$V_{R} = 600 \text{ V}; \text{ I}_{F} = 40 \text{ A}; \text{ d}_{F}/\text{dt} = 500 \text{ A}/\text{us}$	-	1660	-	nC
I _{RM}	Reverse recovery peak current		-	16	-	A
t _{rr}	Reverse recovery time	$T_j = 175 °C;$	-	453	-	nS
Q _r	Reverse recovery charge	$V_{R} = 600 \text{ V}; \text{ I}_{F} = 40 \text{ A}; \text{ dI}_{F}/\text{dt} = 500 \text{ A}/\text{us}$	-	5566	-	nC
I _{RM}	Reverse recovery peak current		-	26	-	А

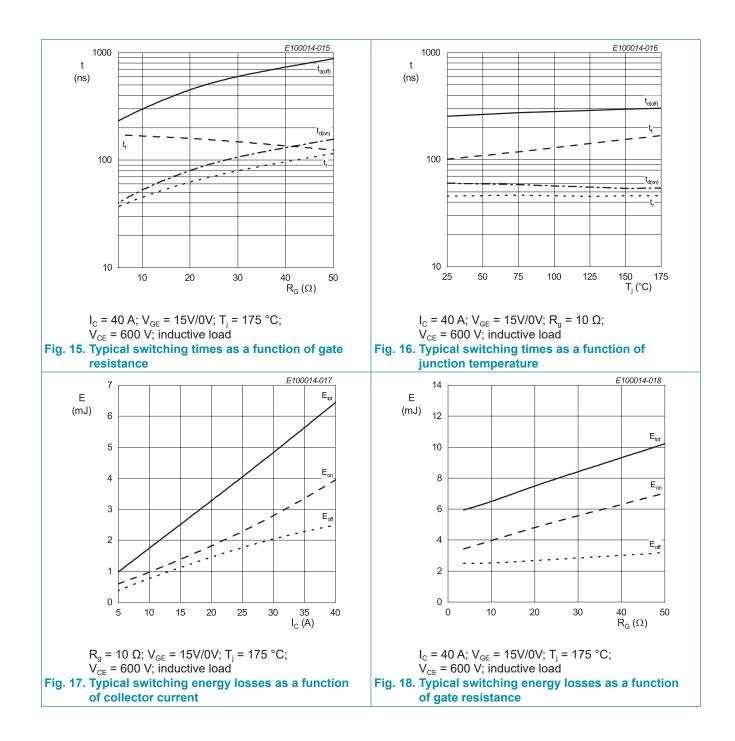
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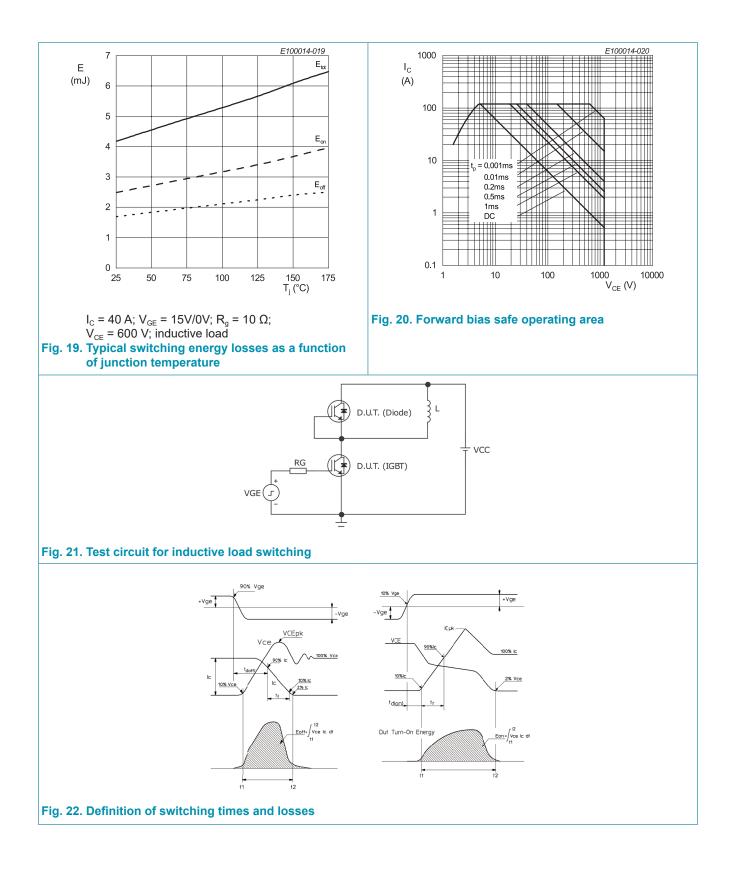
WG40N120MFW1

E100014-003 E100014-004 800 140 $\mathsf{P}_{\mathrm{tot}}$ $I_{\rm C}$ (W) 700 (A) 120 600 100 500 80 400 60 300 40 200 20 100 0 0 150 T_c (°C) 75 175 25 50 100 125 25 50 75 100 125 150 175 T_c (°C) $V_{GE} \ge 15 \text{ V}; \text{ T}_{j} \le 175 \text{ °C}$ Fig. 4. Collector current as a function of case T_i ≤ 175 °C Fig. 3. Power dissipation as a function of case temperature temperature E100014-005 E100014-006 120 120 V_{GE}=20V V_{GE}=20V $I_{\rm C}$ $I_{\rm C}$ 17V 17V (A) 105 (A) 105 15V 15V 13V 11V 9V 13V 11V 90 90 9V 7V 7V 75 75 60 60 45 45 30 30 15 15 0 0 0 1 2 3 4 5 6 0 1 2 3 4 5 6 V_{CE} (V) $V_{CE}^{-}(V)$ T_i = 25 °C T_i = 175 °C Fig. 5. Typical output characteristic Fig. 6. Typical output characteristic

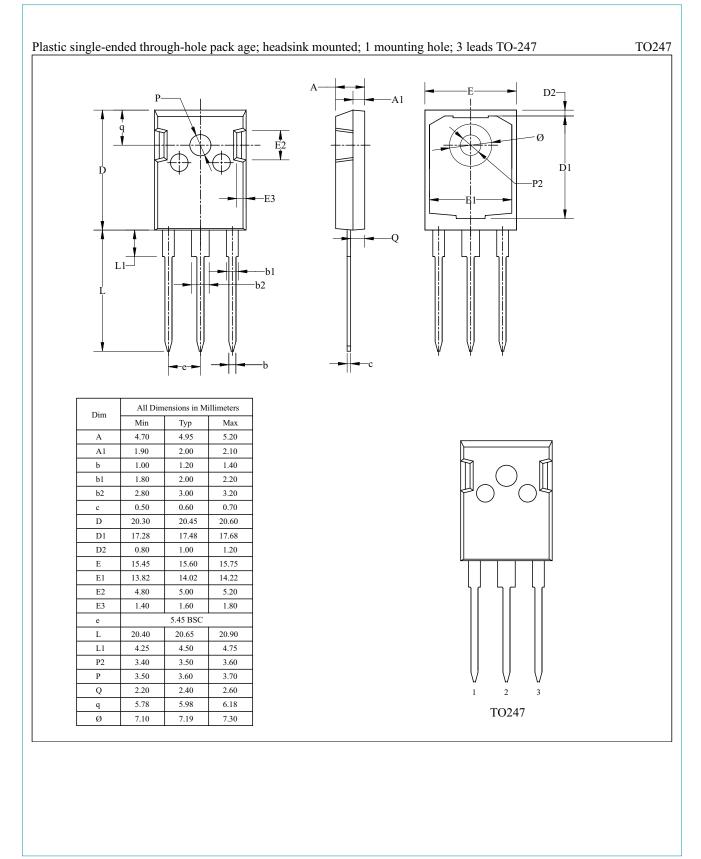








12. Package outline



WG40N120MFW1

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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